

Jetting Paste

PicoShot™ NC-5M

Mycronic Approved

- Jetting solder paste designed and approved for Mycronic MY600 and MY700 jetting systems
 - Standard metal load: 85%
- No-clean solder paste with **identical flux chemistry to Indium8.9HF Solder Paste**
- Exceptional jetting performance for halogen-free and lead-free paste
 - Consistent precision deposition (x, y) targeting
 - Jetting life (syringe) >8 hours
- Reduces head-in-pillow (HIP) defects
- Eliminates or significantly reduces graping
- Minimizes reflow spatter

Type 5
Required

Proven:
>30 Million
Dots/Syringe
in Lab Testing

Contact our engineers: askus@indium.com
Learn more: www.indium.com/jetting-paste

All of Indium Corporation's solder paste and preform manufacturing facilities are IATF 16949:2016 certified. Indium Corporation is an ISO 9001:2015 registered company.

Jetting and Microdispensing Paste

Indium12.8HF

Versatile Paste for Various Systems

- Engineered to fit into a variety of jetting and microdispense systems
 - Flexible metal load (78-85%) to provide optimal dispensability
 - Fine-powder adaptability: Type 5, Type 5 MC, Type 6, Type 6 SG, Type 6 SGS, Type 7, Type 7 SGS
- Exceptional jetting and microdispensing performance for halogen-free and lead-free paste
 - Proven: Smooth, fast dispense
- No-clean solder paste with **identical flux chemistry to Indium8.9HF Solder Paste**



Recommended
Type 6

**Proven:
Advanced
Performance**

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